

L Number	Hits	Search Text	DB	Time stamp
-	1	20020063841.pn.	USPAT; US-PGPUB	2003/10/27 11:30
-	398	349/142	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 11:26
-	1263	349/143	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 11:26
-	650	349/123	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 11:26
-	1467	349/5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 11:27
-	5566	pixel\$4 and adjoin\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 11:31
-	1648	(pixel\$4 and adjoin\$4) and potential	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 11:31
-	39	(pixel\$4 and adjoin\$4) and potential and equipotential	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:06
-	14	(pixel with face) and (pixel with end) and (disclination and leakage)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/27 09:57
-	398	(pixel\$4 and adjoin\$4) and (face same (scan\$4 or gate) and (data or source))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:10
-	0	(pixel\$4 and adjoin\$4) and (face same (scan\$4 or gate) and (data or source)) and 349/142	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:09
-	10	(pixel\$4 and adjoin\$4) and 349/142	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:10
-	53	(pixel\$4 and adjoin\$4) and 349/143	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:19
-	15	(pixel\$4 and adjoin\$4) and 349/123	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:20

	32	(pixel\$4 and adjoin\$4) and 349/5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:20
	10	(pixel\$4 and adjoin\$4) and 349/146	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:21
	103	349/146	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:31
	63920	semiconductor.as.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:32
	3942	semiconductor.as. and (pixel or picture)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:33
	1	semiconductor.as. and (pixel or picture) and adjoin\$4 and (inversion adj drive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:35
	96	semiconductor.as. and (pixel or picture) and adjoin\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/21 15:35
	1	20020113930.pn.	USPAT; US-PGPUB	2003/10/24 16:10
	88	(pixel with end) and (disclination and leakage)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/27 09:28
	42	(pixel with end) and (disclination and leakage) and face	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/27 09:28
	459	(pixel with face) and (pixel with end) and drive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/27 09:58
	197	(pixel with face) and (pixel with end) and (line with drive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/27 09:58
	76	(pixel with face) and (pixel with end) and (line with drive) and 349/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/27 09:59